## < DUPONT >

# DuPont<sup>™</sup> Pyralux<sup>®</sup> FR

Flame Retardant Acrylic-Based Bond Ply

Flexible Circuit Materials

#### **Product Description**

DuPont<sup>™</sup> Pyralux<sup>®</sup> FR Bond Ply features DuPont<sup>™</sup> Kapton<sup>®</sup> polyimide film, coated on both sides with a proprietary flame retardant B-staged modified acrylic adhesive. This bond ply can be used to encapsulate etched details for environmental protection and electrical insulation. Using bond ply can eliminate a layer of Kapton<sup>®</sup> dielectric and a layer of adhesive in low layer count multilayer constructions.

#### **Key Features and Benefits**

- Flame retardant modified acrylic adhesive composition
- Excellent bond strength affords high reliability
- $\boldsymbol{\cdot}$  Able to withstand multiple lamination cycles
- No refrigeration required for storage
- Certified to IPC-4203/1
- UL 94 VTM-0, UL File E124294
- RoHS Compliant

#### Packaging

Pyralux<sup>®</sup> FR Bond Ply is supplied on 24 in (610 mm) wide by 250 ft (76 m) long rolls, on nominal 3 in (76 mm) cores. Narrower widths or cut sheets are also available by special order.

#### Storage Conditions and Warranty

DuPont<sup>™</sup> Pyralux<sup>®</sup> FR Bond Ply should be stored in original packaging at temperatures of 4 - 29 °C (40 - 85 °F) and below 70% relative humidity. The product should not be frozen and should be kept dry, clean, and well-protected. Subject to compliance with the foregoing handling and storage recommendations, DuPont's warranties as provided in the DuPont Standard Conditions of Sale shall remain in effect for a period of two years following the date on the Certificate of Analysis.

#### Processing

Lamination conditions for DuPont<sup>™</sup> Pyralux<sup>®</sup> FR flexible circuit materials are typically in the following ranges:

| Part Temperature: | 182 - 199 °C (360 - 390 °F) |
|-------------------|-----------------------------|
| Pressure:         |                             |
| Time:             |                             |

Pyralux<sup>®</sup> FR Bond Ply processing guide available from your DuPont sales representative.

#### Table 1 - Standard Pyralux<sup>®</sup> FR Bond Ply Offerings

| Product Code | Adhesive Thickness<br>µm (mil) | Kapton® Thickness<br>µm (mil) |
|--------------|--------------------------------|-------------------------------|
| FR7016       | 25 (1.0)                       | 13 (0.5)                      |
| FR0111       | 25 (1.0)                       | 25 (1.0)                      |
| FR0121       | 25 (1.0)                       | 51 (2.0)                      |
| FR0131       | 25 (1.0)                       | 76 (3.0)                      |
| FR0212       | 51 (2.0)                       | 25 (1.0)                      |
| FR7021       | 13 (0.5)                       | 13 (0.5)                      |
| FR1515       | 13 (0.5)                       | 25 (1.0)                      |

#### Pyralux<sup>®</sup> FR Bond Ply Construction Selection

A variety of Pyralux® FR Bond Ply constructions, both balanced and unbalanced, are commercially available. For help beyond the standard offerings in Table 1, please use the Laminate Product Selector at pyralux.dupont.com to identify the appropriate product code for your bond ply solution.



#### Safe Handling

Prior to handling, DuPont recommends referencing the Pyralux<sup>®</sup> Safe Handling Guide available at pyralux.dupont.com. Pyralux<sup>®</sup> FR flexible circuit materials DO NOT contain polybrominated biphenyls (PBBs), polybrominated biphenyl oxides (PBBOs), or polybrominated diphenyl ethers (PBDEs).

#### **Quality and Traceability**

DuPont<sup>™</sup> Pyralux<sup>®</sup> FR Bond Ply is manufactured under a certified ISO9001:2015 Quality Management System facility. Complete material and manufacturing records, which include archive samples of finished product, are maintained by DuPont. Each manufactured lot is identified for reference traceability. The packaging label serves as the primary tracking mechanism in the event of customer inquiry and includes the product name, batch number, size, and quantity.

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#### Product Performance

#### Table 2 - DuPont<sup>™</sup> Pyralux<sup>®</sup> FR Bond Ply Properties

| Property   | FR0111 Typical Value   | Test Method                      |
|--|------------------------|----------------------------------|
| Dielectric Constant (Dk)<br>1 MHz<br>10 GHz  | 3.6<br>3.0             | IPC-TM-650 2.5.5.3<br>ASTM D2520 |
| Loss Tangent (Df)<br>1 MHz<br>10 GHz   | 0.020<br>0.017         | IPC-TM-650 2.5.5.3<br>ASTM D2520 |
| Peel Strength* (Adhesion to Copper)<br>As Received, N/mm (lb/in)<br>After Solder, N/mm (lb/in) | 1.6 (9.0)<br>1.6 (9.0) | IPC-TM-650 2.4.9                 |
| Adhesive Flow, mm (mil)  | 0.10 - 0.15 (4 - 6)    | IPC-TM-650 2.3.17.1              |
| Dimensional Stability (MD/TD)  | ± 0.03 %               | IPC-TM-650 2.2.4                 |
| Solder Float, 288 °C for 10 s  | Pass                   | IPC-TM-650 2.4.13                |
| Volume Resistivity, Ω · cm   | > 10 <sup>15</sup>     | IPC-TM-650 2.5.17                |
| Surface Resistance, $\Omega$   | > 10 <sup>13</sup>     | IPC-TM-650 2.5.17                |

Data within this table are typical values for the listed product. Performance can vary depending on construction and processing.

\*Lamination Conditions: 14 kg/cm<sup>2</sup> (200 psi) at 182 °C (360 °F) for 1 hour to treated side of 1 oz RA copper foil.



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For more information on DuPont™ FR Bond Ply or other DuPont products, please visit our website.

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CAUTION: Do not use in medical applications involving permanent implantation in the human body. For other medical applications, see "DuPont Medical Caution Statement," H-50102-5 and "DuPont Policy Regarding Medical Applications" H-50103-5..

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